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|-----------------------------------|--|-------------------------|-----------------------------------------|-------------|
| <b>Notice of References Cited</b> |  | Application/Control No. | Applicant(s)/Patent Under Reexamination |             |
|                                   |  | 10/025,780              | PARK ET AL                              |             |
| Examiner                          |  | Art Unit                |                                         | Page 1 of 1 |
| Sonny TRINH                       |  | 2687                    |                                         |             |

**U.S. PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name                | Classification |
|---|---|--------------------------------------------------|-----------------|---------------------|----------------|
| * | A | US-6,847,327                                     | 01-2005         | Ylitalo, Juha       | 342/407        |
| * | B | US-6,026,304                                     | 02-2000         | Hilsenrath et al.   | 455/456.2      |
| * | C | US-6,249,680                                     | 06-2001         | Wax et al.          | 455/456.2      |
| * | D | US-2005/0136841                                  | 06-2005         | Frank, Colin        | 455/065        |
| * | E | US-6,600,445                                     | 07-2003         | Li, Shihe           | 342/368        |
| * | F | US-2003/0152099                                  | 08-2003         | Chun et al.         | 370/441        |
| * | G | US-2005/0025223                                  | 02-2005         | Dabak et al.        | 375/147        |
| * | H | US-6,108,565                                     | 08-2000         | Scherzer, Shimon B. | 455/562.1      |
| * | I | US-2003/0216156                                  | 11-2003         | Chun, Byung-Jin     | 455/562.1      |
| * | J | US-2003/0048760                                  | 03-2003         | Park et al.         | 370/295        |
|   | K | US-                                              |                 |                     |                |
|   | L | US-                                              |                 |                     |                |
|   | M | US-                                              |                 |                     |                |

**FOREIGN PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name | Classification |
|---|---|--------------------------------------------------|-----------------|---------|------|----------------|
|   | N |                                                  |                 |         |      |                |
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|   | R |                                                  |                 |         |      |                |
|   | S |                                                  |                 |         |      |                |
|   | T |                                                  |                 |         |      |                |

**NON-PATENT DOCUMENTS**

|   |   |                                                                                           |
|---|---|-------------------------------------------------------------------------------------------|
| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|   | U |                                                                                           |
|   | V |                                                                                           |
|   | W |                                                                                           |
|   | X |                                                                                           |

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